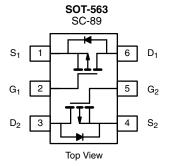
HALOGEN

FREE



Dual P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (mA)				
- 20	1.2 at V _{GS} = - 4.5 V	- 350				
	1.6 at V _{GS} = - 2.5 V	- 300				
	2.7 at V _{GS} = - 1.8 V	- 150				



Ordering Information: Si1023X-T1-GE3 (Lead (Pb)-free and Halogen-free)

Marking Code: B

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET: 1.8 V Rated
- Very Small Footprint
- · High-Side Switching
- Low On-Resistance: 1.2 Ω
- Low Threshold: 0.8 V (typ.)
- Fast Switching Speed: 14 ns
- 1.8 V Operation
- Gate-Source ESD Protected: 2000 V
- Compliant to RoHS Directive 2002/95/EC

BENEFITS

- · Ease in Driving Switches
- · Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- · Power Supply Converter Circuits
- · Load/Power Switching Cell Phones, Pagers

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)									
Parameter		Symbol	5 s Steady State		Unit				
Drain-Source Voltage		V_{DS}	- 20		V				
Gate-Source Voltage		V_{GS}	± 6						
Continuous Drain Current /T 150 °C\a	T _A = 25 °C	- I _D	- 390	- 370	^				
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 280	- 265					
Pulsed Drain Current ^b		I _{DM}	- 650		mA mA				
Continuous Source Current (Diode Conduction) ^a		I _S	- 450 - 380						
Mariana Barra Biratia di ad	T _A = 25 °C	P _D	280	250	mW				
Maximum Power Dissipation ^a	T _A = 85 °C		145	130					
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C				
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000		V				

Notes:

- a. Surface mounted on FR4 board.
- b. Pulse width limited by maximum junction temperature.

Document Number: 71169 S10-2432-Rev. C, 25-Oct-10

Vishay Siliconix



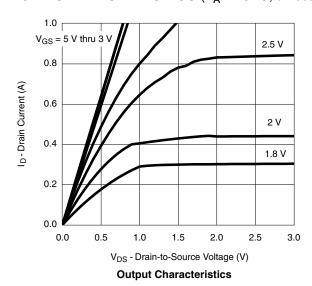
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)											
Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit					
Static											
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45			V					
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$		± 1	± 2	μΑ					
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$		- 0.3	- 100	nA					
		V _{DS} = - 16 V, V _{GS} = 0 V, T _J = 85 °C			- 5	μΑ					
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 700			mA					
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -350 \text{ mA}$		0.8	1.2	Ω					
		V _{GS} = - 2.5 V, I _D = - 300 mA		1.2	1.6						
		V _{GS} = - 1.8 V, I _D = - 150 mA		1.8	2.7						
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 250 mA		0.4		S					
Diode Forward Voltage ^a	V_{SD}	I _S = - 150 mA, V _{GS} = 0 V		- 0.8	- 1.2	V					
Dynamic ^b											
Total Gate Charge	Q_g			1500							
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -250 \text{ mA}$		150		рС					
Gate-Drain Charge	Q_{gd}			450							
Turn-On Time	t _{d(on)}	V_{DD} = -10 V, R_L = 47 Ω		14		ns					
Turn-Off Time	t _{d(off)}	$I_D \cong$ - 200 mA, V_{GEN} = - 4.5 V, R_g = 10 Ω		46							

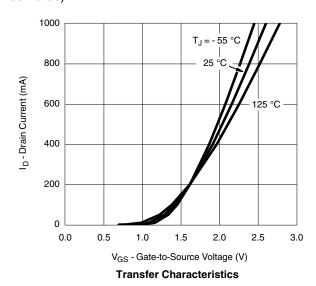
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

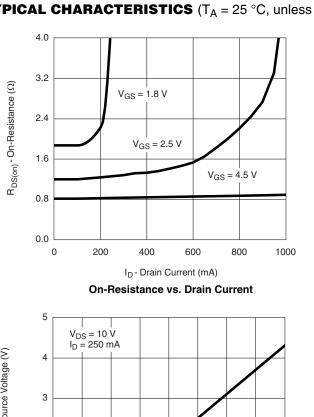
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

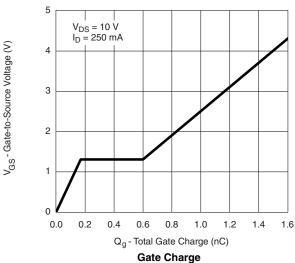


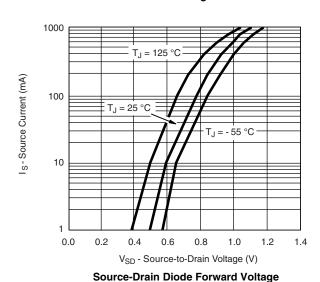


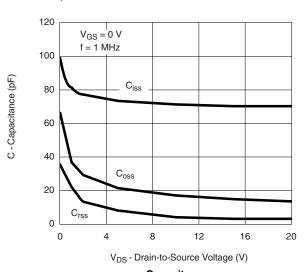


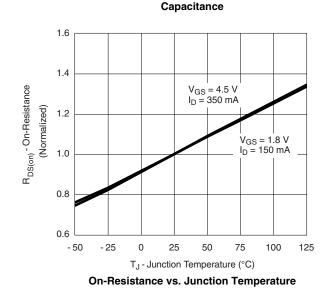
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

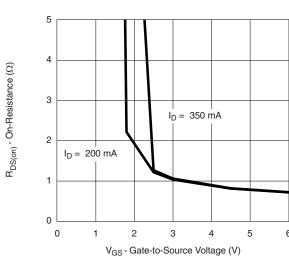










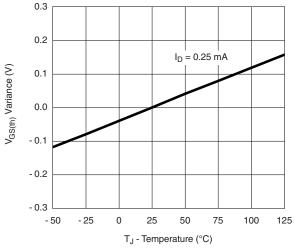


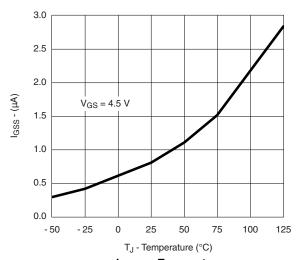
On-Resistance vs. Gate-to-Source Voltage

Vishay Siliconix

VISHAY

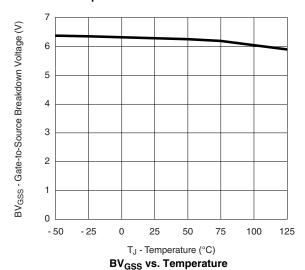
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

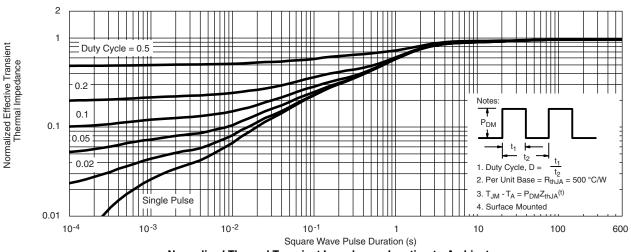




Threshold Voltage Variance vs. Temperature







Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71169.

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 www.vishay.com
Revision: 11-Mar-11 1